



## UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS  
 UNITED STATES PATENT AND TRADEMARK OFFICE  
 WASHINGTON, D.C. 20231  
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*SMP*

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/042,829	01/08/2002	Chi Wah Cheng	P/4076-10

CONFIRMATION NO. 7316

000002352  
 OSTROLENK FABER GERB & SOFFEN  
 1180 AVENUE OF THE AMERICAS  
 NEW YORK, NY 100368403

## FORMALITIES LETTER



\*OC00000007473729\*

Date Mailed: 02/14/2002

## NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

*Filing Date Granted*

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is unsigned.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- **The balance due by applicant is \$ 130.**

The application is informal since it does not comply with the regulations for the reason(s) indicated below.

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:

- drawings have a line quality that is too light to be reproduced (weight of all lines and letters must be heavy enough to permit adequate reproduction) or text that is illegible (reference characters, sheet numbers, and view numbers must be plain and legible) see 37 CFR 1.84(l) and (p)(1));

04/19/2002 SSESHE1 00000082 10042829

01 FC:105

130.00 DP

*A copy of this notice **MUST** be returned with the reply.*

*Chi C*

PART 2 - COPY TO BE RETURNED WITH RESPONSE



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of  
 Che Wah CHENG, et al.  
 Serial No.: 10/042,829  
 Filed: January 8, 2002

Date: April 12, 2002  
 Group Art Unit: ---  
 Examiner: ---

## For: APPARATUS AND METHOD OF PLACING SOLDER BALLS ONTO A SUBSTRATE

Asst. Commissioner for Patents  
 Washington, DC 20231  
 Attention: Application Branch

**RESPONSE TO NOTICE TO FILE MISSING  
 PARTS OF APPLICATION - FILING DATE GRANTED**

Sir:

In response to the Notice to File Missing Parts of Application - Filing Date Granted, mailed February 14, 2002, submitted herewith is the Inventor(s) Declaration and our Check No. \_08839\_ which includes the amount of \$130.00 (Large Entity) in payment of the surcharge.

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee during the prosecution of this application is not paid, the Patent Office is authorized to charge the underpayment to Deposit Account #15-0700.

If this communication is filed after the time period had elapsed and no separate Petition is enclosed, the Commissioner of Patents and Trademarks is petitioned, under 37 C.F.R. §1.136(a), to extend the time for filing a response by the number of months which will avoid abandonment under 37 C.F.R. §1.135. The fee under 37 C.F.R. § 1.17 should be charged to our Deposit Account No. 15-0700.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Asst. Comm. for Patents, Washington, D.C. 20231, on April 12, 2002:

Robert C. Faber

Name of applicant, assignee or  
 Registered Representative

Signature

April 12, 2002

Date of Signature

RCF:sds

Enclosures

Respectfully submitted,

Robert C. Faber  
 Registration No.:24,322  
 OSTROLENK, FABER, GERB & SOFFEN, LLP  
 1180 Avenue of the Americas  
 New York, New York 10036-8403  
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OFGS File No.:P/4076-10

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In re Patent Application of

Chi Wah CHENG, et al.

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Asst. Commissioner for Patents  
Washington, D.C. 20231

SUBMISSION

Sir:

Submitted herewith is a copy of prior art together with a form listing the same for the convenience of the Examiner.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on April 12, 2002

Robert C. Faber Esq.

Respectfully submitted,

Robert C. Faber  
Registration No.: 24,322  
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Name of applicant, assignee or  
Registered Representative

Signature

April 12, 2002

Date of Signature

RCF:sds  
Enclosures